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74VHC161284 IEEE 1284 Transceiver

FAIRCHILD

74VHC161284 IEEE 1284 Transceiver

General Description

The VHC161284 contains eight bidirectional data buffers and eleven control/status buffers to implement a full IEEE 1284 compliant interface. The device supports the IEEE 1284 standard and is intended to be used in Extended Capabilities Port mode (ECP). The pinout allows for easy connection from the Peripheral (A-side) to the Host (cable side).

Outputs on the cable side can be configured to be either open drain or high drive (\pm 14 mA). The pull-up and pull-down series termination resistance of these outputs on the cable side is optimized to drive an external cable. In addition, all inputs (except HLH) and outputs on the cable side contain internal pull-up resistors connected to the V_{CC} supply to provide proper termination and pull-ups for open drain mode.

Outputs on the Peripheral side are standard LOW-drive CMOS outputs. The DIR input controls data flow on the A_1 - A_8/B_1 - B_8 transceiver pins.

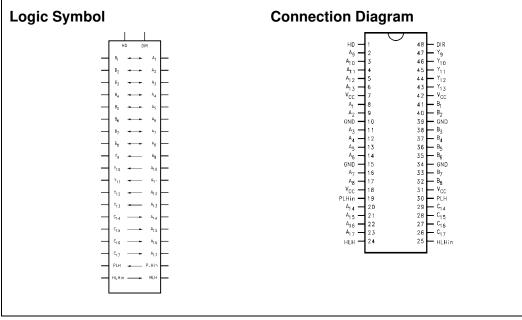
Features

- Supports IEEE 1284 Level 1 and Level 2 signaling standards for bidirectional parallel communications between personal computers and printing peripherals
- Replaces the function of two (2) 74ACT1284 devices
- All inputs have hysteresis to provide noise margin
- B and Y output resistance optimized to drive external cable
- B and Y outputs in high impedance mode during power down
- Inputs and outputs on cable side have internal pull-up resistors
- Flow-through pin configuration allows easy interface between the Peripheral and Host

Ordering Code:

Ordering Number	Package Number	Package Description
74VHC161284MEA	MS48A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
74VHC161284MTD	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.



Pin Descriptions Truth Table Pin Names Inputs Description Outputs HD DIR HD HIGH Drive Enable Input (Active HIGH) DIR Direction Control Input B₁-B₈ Data to A₁-A₈, and L L $A_1 - A_8$ Inputs or Outputs $A_9 - A_{13}$ Data to $Y_9 - Y_{13}$ (Note 1) B₁–B₈ Inputs or Outputs C₁₄-C₁₇ Data to A₁₄-A₁₇ A₉-A₁₃ Inputs PLH Open Drain Mode Y₉–Y₁₃ Outputs L Н B₁–B₈ Data to A₁–A₈, and Outputs A₁₄-A₁₇ A₉-A₁₃ Data to Y₉-Y₁₃ C₁₄-C₁₇ Inputs C₁₄-C₁₇ Data to A₁₄-A₁₇ Peripheral Logic HIGH Input A1-A8 Data to B1-B8 (Note 2) PLH_{IN} Н L Peripheral Logic HIGH Output $A_9 - A_{13}$ Data to $Y_9 - Y_{13}$ (Note 1) PLH HLHIN C₁₄-C₁₇ Data to A₁₄-A₁₇ Host Logic HIGH Input HLH Host Logic HIGH Output PLH Open Drain Mode A1-A8 Data to B1-B8 Н Н A₉-A₁₃ Data to Y₉-Y₁₃ C₁₄-C₁₇ Data to A₁₄-A₁₇ Note 1: Y9-Y13 Open Drain Outputs Note 2: B1-B8 Open Drain Outputs Logic Diagram -A8 $A_{9} - A_{13}$ $A_{14} - A_{17}$ PLHin HLH Α1 DI B₁ - B₈ Y₉-Y₁₃ $C_{14} - C_{17}$ PLH HLHin 1-of-5 1-of-4 1-of-8 į

Absolute Maximum Ratings(Note 3) Rec Supply Voltage Con V_{CC} -0.5V to + 7.0V Input Voltage (V_I) (Note 4) V_{CC} A₁-A 1₃, PLH_{IN}, DIR, HD -0.5V to V_{CC} + 0.5V

-0.5V to V_{CC} + 0.5V

-0.5V to + 5.5V (DC)

-2.0V to + 7.0V* *40 ns Transient

±25 mA

±50 mA

84 mA

-50 mA

-20 mA

±50 mA

–50 mA

±200 mA

2000V

-65°C to + 150°C

B₁-B₈, C₁₄-C₁₇, HLH_{IN}

B₁–B₈, C₁₄–C₁₇, HLH_{IN}

A₁-A₈, A₁₄-A₁₇, HLH B₁-B₈, Y₉-Y₁₃, PLH

B1-B8, Y9-Y13, PLH

DC Output Current (I_O) A_1 – A_8 , HLH

PLH (Output LOW)

PLH (Output HIGH)

Output Diode Current (I_{OK})

 $\begin{array}{l} {\sf A}_1 {\rm - A}_8, \, {\sf A}_{14} {\rm - A}_{17}, \, {\sf HLH} \\ {\sf B}_1 {\rm - B}_8, \, {\sf Y}_9 {\rm - Y}_{13}, \, {\sf PLH} \end{array}$

DC Continuous V_{CC} or

Ground Current

Storage Temperature

Voltage

ESD (HBM) Last Passing

Input Diode Current (I_{IK}) (Note 4) DIR, HD, A₉–A₁₃, PLH, HLH, C₁₄–C₁₇

B₁–B₈, Y₉–Y₁₃

Output Voltage (V_O)

Recommended Operating Conditions

74VHC161284

4.5V to 5.5V

0V to V_{CC}

0V to 5.5V

-40°C to + 85°C

$\begin{array}{c} -0.5V \ to + 7.0V \\ -0.5V \ to \ V_{CC} + 0.5V \\ -0.5V \ to \ V_{CC} + 0.5V \\ -0.5V \ to \ + 5.5V \ (DC) \\ -2.0V \ to + 7.0V \\ *40 \ ns \ Transient \end{array} \begin{array}{c} \text{Supply Voltage} \\ V_{CC} \\ DC \ Input \ Voltage \ (V_I) \\ Open \ Drain \ Voltage \ (V_O) \\ Operating \ Temperature \ (T_A) \\ \end{array}$

Note 3: Absolute Maximum continuos ratings are those values beyond which damage to the device may occur. Exposure to these indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied.

Note 4: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter		V _{cc} (V)	$T_A = -40^{\circ}C$ to +85°C Guaranteed Limits	Units	Conditions
V _{IK}	Input Clamp Diode Voltage		3.0	-1.2	V	I _I = -18 mA
VIH	Minimum HIGH Level Input Voltage	A _n , PLH _{IN} , DIR, HD	4.5 – 5.5	0.7 V _{CC}		
		B _n	4.5 – 5.5	2.0	v	
		C _n	4.5 – 5.5	2.3	v	
		HLH _{IN}	4.5 – 5.5	2.6		
V _{IL}	Maximum LOW Level Input Voltage	A _n , PLH _{IN} , DIR, HD	4.5 – 5.5	0.3 V _{CC}		
		B _n	4.5 – 5.5	0.8	v	
		C _n	4.5 - 5.5	0.8	v	
		HLH _{IN}	4.5 - 5.5	1.6		
ΔVT	Minimum Input Hysteresis	A _n , PLH _{IN} , DIR, HD	4.5 - 5.5	0.4		$V_{T}^{+} - V_{T}^{-}$
		B _n	4.5 – 5.5	0.4	V	$V_{T^{+}} - V_{T^{-}}$
		C _n	5.0	0.8		V _T + –V _T –
		HLH _{IN}	5.0	0.3		$V_{T}^{+} - V_{T}^{-}$
V _{ОН}	Minimum HIGH Level Output Voltage	A _n , HLH	4.5	4.4		$I_{OH} = -50 \ \mu A$
			4.5	3.8	v	$I_{OH} = -8 \text{ mA}$
		B _n , Y _n	4.5	3.73	v	$I_{OH} = -14 \text{ mA}$
		PLH	4.5	4.45		$I_{OH} = -500 \ \mu A$

74VHC161284

DC Electrical Characteristics (Continued)

Symbol	Parameter		V _{cc}	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	Units	Conditions
0,	r didirictor			Guaranteed Limits	•	Conditions
V _{OL}	Maximum LOW Level Output Voltage	A _n , HLH	4.5	0.1		$I_{OL} = 50 \ \mu A$
			4.5	0.44	v	$I_{OL} = 8 \text{ mA}$
		B _n , Y _n	4.5	0.77	v	$I_{OL} = 14 \text{ mA}$
		PLH	4.5	0.7		$I_{OL} = 84 \text{ mA}$
RD	Maximum Output Impedance	B ₁ -B ₈ , Y ₉ -Y ₁₃	5.0	55	Ω	(Note 5)(Note 6)
	Minimum Output Impedance	B ₁ -B ₈ , Y ₉ -Y ₁₃	5.0	35	Ω	(Note 5)(Note 6)
RP	Maximum Pull-Up Resistance	B ₁ -B ₈ , Y ₉ -Y ₁₃ , C ₁₄ -C ₁₇	5.0	1650	Ω	
	Minimum Pull-Up Resistance	B ₁ -B ₈ , Y ₉ -Y ₁₃ , C ₁₄ -C ₁₇	5.0	1150	Ω	
I _{IH}	Maximum Input Current in HIGH State	A ₉ –A ₁₃ , PLH _{IN} , HD, DIR, HLH _{IN}	5.5	1.0	μА	$V_I = 5.5V$
		C ₁₄ -C ₁₇	5.5	100	μΑ	$V_I = 5.5V$
I _{IL}	Maximum Input Current in LOW State	A ₉ –A ₁₃ , PLH _{IN} , HD, DIR, HLH _{IN}	5.5	-1.0	μA	$V_I = 0.0V$
		C ₁₄ -C ₁₇	5.5	-5.0	mA	$V_{I}=0.0V$
I _{OZH}	Maximum Output Disable Current	A ₁ —A ₈	5.5	20	μА	$V_{O} = 5.5V$
	(HIGH)	B ₁ -B ₈	5.5	100	μΛ	$V_O = 5.5V$
I _{OZL}	Maximum Output Disable Current	A ₁ —A ₈	5.5	-20	μA	$V_{O} = 0.0V$
	(LOW)	B ₁ -B ₈	5.5	-5.0	mA	
I _{OFF}	Power Down Output Leakage	B ₁ –B ₈ , Y ₉ –Y ₁₃ , PLH	0.0	100	μA	$V_O = 5.5V$
I _{OFF}	Power Down Input Leakage	C ₁₄ -C ₁₇ , HLH _{IN}	0.0	100	μA	$V_I = 5.5V$
I _{OFF} – I _{CC}	Power Down Leakage to V _{CC}		0.0	250	μA	(Note 7)
I _{CC}	Maximum Supply Current		5.5	70	mA	$V_I = V_{CC}$ or GND

Note 5: Output impedance is measured with the output active LOW and active HIGH (HD = HIGH).

Note 6: This parameter is guaranteed but not tested, characterized only.

Note 7: Power-down leakage to V_{CC} is tested by simultaneously forcing all pins on the cable-side (B₁-B₈, Y₉-Y₁₃, PLH, C₁₄-C₁₇ and HLH_{IN} to 5.5V and measuring the resulting I_{CC}.

	Parameter		C to +85°C		Figure
Symbol		V _{CC} = 4.	$V_{CC}=4.5V-5.5V$		
		Min	Max		Number
PHL	A ₁ -A ₈ to B ₁ -B ₈	2.0	30.0	ns	Figure 1
PLH	$A_1 - A_8$ to $B_1 - B_8$	2.0	30.0	ns	Figure 2
t _{PHL}	$B_1 - B_8$ to $A_1 - A_8$	2.0	30.0	ns	Figure 3
t _{PLH}	B ₁ -B ₈ to A ₁ -A ₈	2.0	30.0	ns	Figure 3
t _{PHL}	A ₉ -A ₁₃ to Y ₉ -Y ₁₃	2.0	30.0	ns	Figure 1
t _{PLH}	A ₉ -A ₁₃ to Y ₉ -Y ₁₃	2.0	30.0	ns	Figure 2
t _{PHL}	C ₁₄ -C ₁₇ to A ₁₄ -A ₁₇	2.0	30.0	ns	Figure 3
t _{PLH}	$C_{14}-C_{17}$ to $A_{14}-A_{17}$	2.0	30.0	ns	Figure 3
t _{SKEW}	LH-LH or HL-HL		6.0	ns	(Note 9)
t _{PHL}	PLH _{IN} to PLH	2.0	30.0	ns	Figure 1
t _{PLH}	PLH _{IN} to PLH	2.0	30.0	ns	Figure 2
t _{PHL}	HLH _{IN} to HLH	2.0	30.0	ns	Figure 3
PLH	HLH _{IN} to HLH	2.0	30.0	ns	Figure 3
t _{PHZ}	Output Disable Time	2.0	18.0	ns	Figure 7
t _{PLZ}	DIR to A ₁ -A ₈	2.0	18.0	115	r igule /
t _{PZH}	Output Enable Time	2.0	25.0	ns	Figure 8
t _{PZL}	DIR to A ₁ -A ₈	2.0	25.0	113	
t _{PHZ}	Output Disable Time	2.0	25.0	ns	Figure 9
t _{PLZ}	DIR to B ₁ -B ₈	2.0	25.0	113	
t _{pEN}	Output Enable Time	2.0	28.0	ns	Figure 2
	HD to B ₁ -B ₈ , Y ₉ -Y ₁₃	2.0	20.0	110	r iguið 2
t _{pDis}	Output Disable Time	2.0	28.0	ns	Figure 2
	HD to B ₁ –B ₈ , Y ₉ –Y ₁₃	2.0	20.0	113	riguie z
t _{pEn} -t _{pDis}	Output Enable-Output Disable		20.0	ns	
t _{SLEW}	Output Slew Rate				
t _{PLH}	B ₁ -B ₈ , Y ₉ -Y ₁₃	0.05	0.40	V/ns	Figure 5
t _{PHL}		0.05	0.40	V/115	Figure 4
t _r , t _f	t _{RISE} and t _{FALL}		120	ns	Figure 6
	B ₁ -B ₈ , Y ₉ -Y ₁₃ (Note 8)		120	115	(Note 10)

Note 8: Open Drain

Note 9: t_{SKEW} is measured for common edge output transitions and compares the measured propagation delay for a given path type.

(i) $\mathsf{A}_1\text{--}\mathsf{A}_8$ to $\mathsf{B}_1\text{--}\mathsf{B}_8,\,\mathsf{A}_9\text{--}\mathsf{Y}_{13}$ to $\mathsf{Y}_9\text{--}\mathsf{Y}_{13}$

(ii) $B_1 - B_8$ to $A_1 - A_8$

(iii) C_{14} - C_{17} to A_{14} - A_{17}

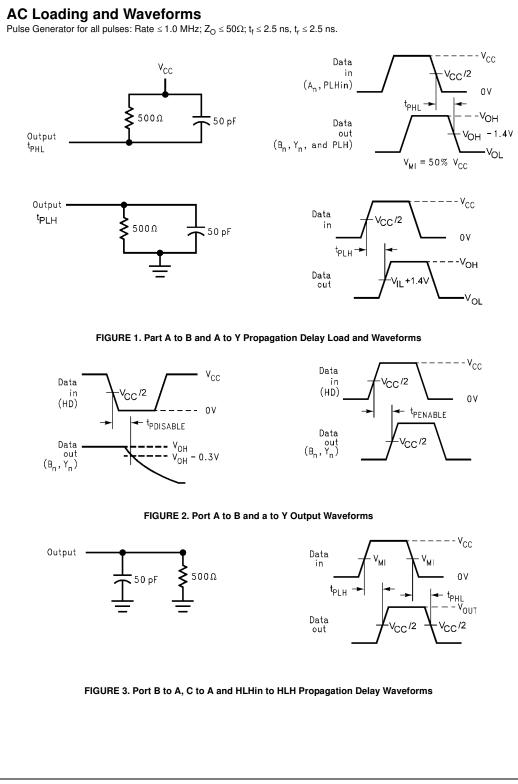
Note 10: This parameter is guaranteed but not tested, characterized only.

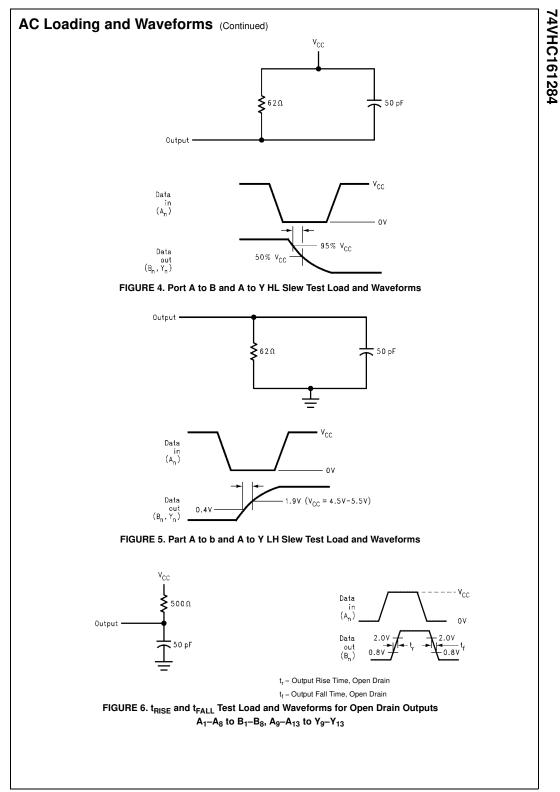
Capacitance (Note 11)

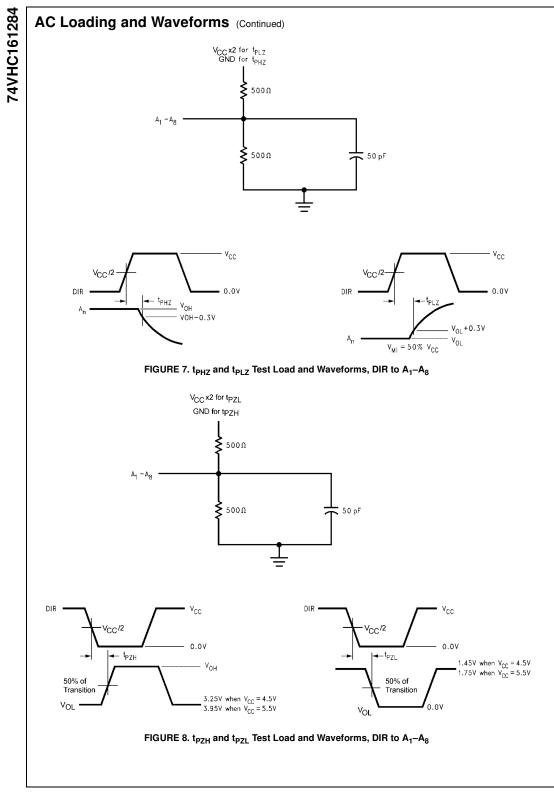
Symbol	Parameter	Тур	Units	Conditions
C _{IN}	Input Capacitance	5	pF	$V_{CC} = 0.0V$ (HD, DIR, A ₉ —A ₁₃ , C ₁₄ —C ₁₇ , PLH _{IN} and HLH _{IN})
C _{I/O}	I/O Pin Capacitance	12	pF	V _{CC} = 3.3V

Note 11: Capacitance is measured at frequency = 1 MHz.



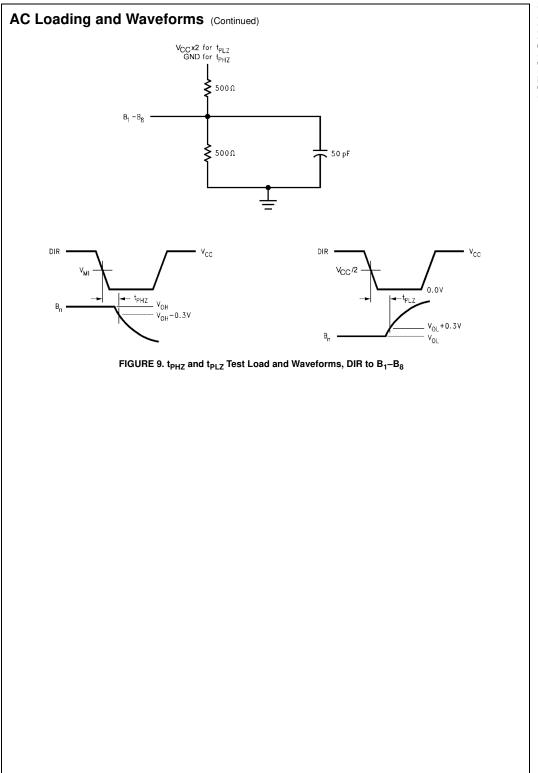




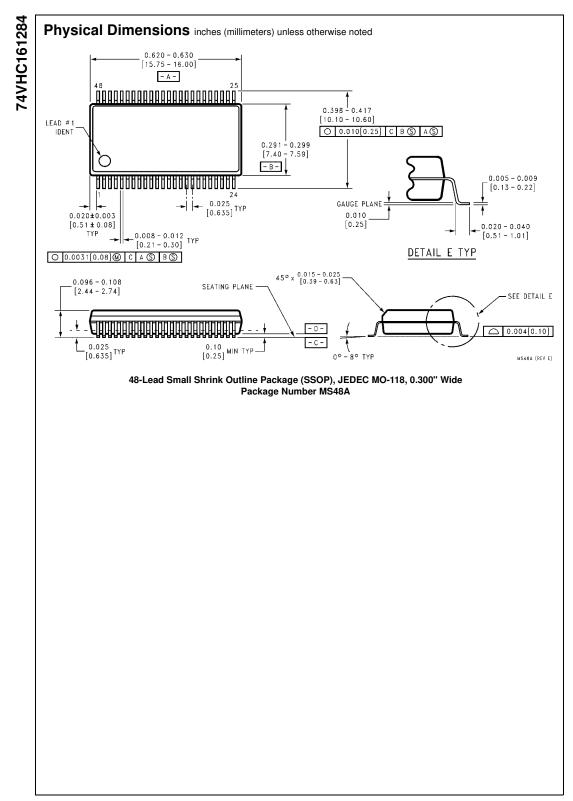


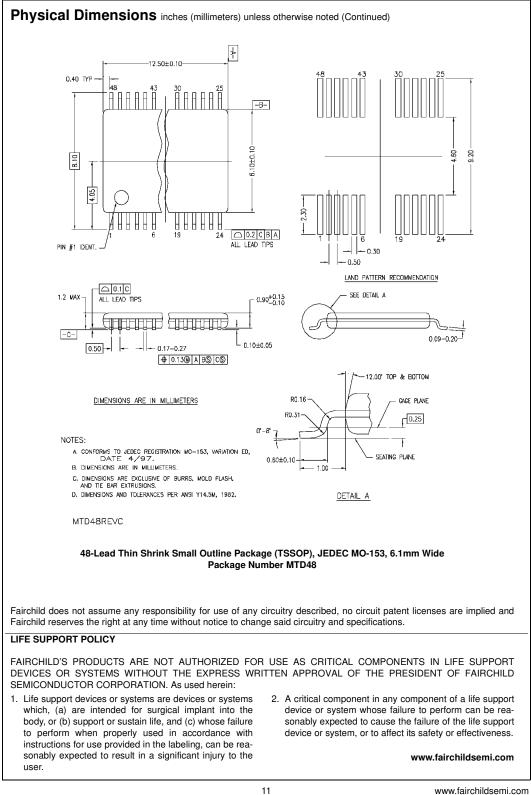
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